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Intel® Core™ i7-6700 Processor (8M Cache, up to 4.00 GHz)

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Specifications			
- Essentials			
Status		Launched	
Launch Date		Q3'15	
Processor Number		i7-6700	
Intel® Smart Cache		8 MB	
DMI3		8 GT/s	
Instruction Set		64-bit	
Instruction Set Extensions		SSE4.1/4.2, AVX 2.0	
Embedded Options Available	Q	Yes	
Lithography		14 nm	
Scalability		1S Only	
Thermal Solution Specification		PCG 2015C (65W)	
Recommended Customer Price			
Datasheet		Link	

- Performance	
# of Cores	4
# of Threads	8
Processor Base Frequency	3.4 GHz
Max Turbo Frequency	4 GHz
TDP	65 W

Memory Specifications	
Max Memory Size (dependent on memory type)	64 GB
Memory Types	DDR4-1866/2133, DDR3L- 1333/1600 @ 1.35V
Max # of Memory Channels	2
Max Memory Bandwidth	34.1 GB/s
ECC Memory Supported ‡	No

Graphics Specifications		
Processor Graphics ‡		Intel® HD Graphics 530
Graphics Base Frequency		350 MHz
Graphics Max Dynamic Frequency		1.15 GHz
Graphics Video Max Memory		1.7 GB
Graphics Output		eDP/DP/HDMI/DVI
4K Support		Yes, at 60Hz
Max Resolution (Intel® WiDi)‡		1080p
Max Resolution (HDMI 1.4)‡		4096x2304@24Hz
Max Resolution (DP)‡		4096x2304@60Hz
Max Resolution (eDP - Integrated Flat Panel)‡		4096x2304@60Hz
Max Resolution (VGA)‡		N/A
DirectX* Support		12
OpenGL* Support		4.4
Intel® Quick Sync Video	Q	Yes
Intel® InTru™ 3D Technology		Yes
Intel® Insider™		Yes
Intel® Wireless Display	Q	Yes
Intel® Clear Video HD Technology		Yes
Intel® Clear Video Technology		Yes
# of Displays Supported ‡		3
Device ID		0x1912

- Expansion Options

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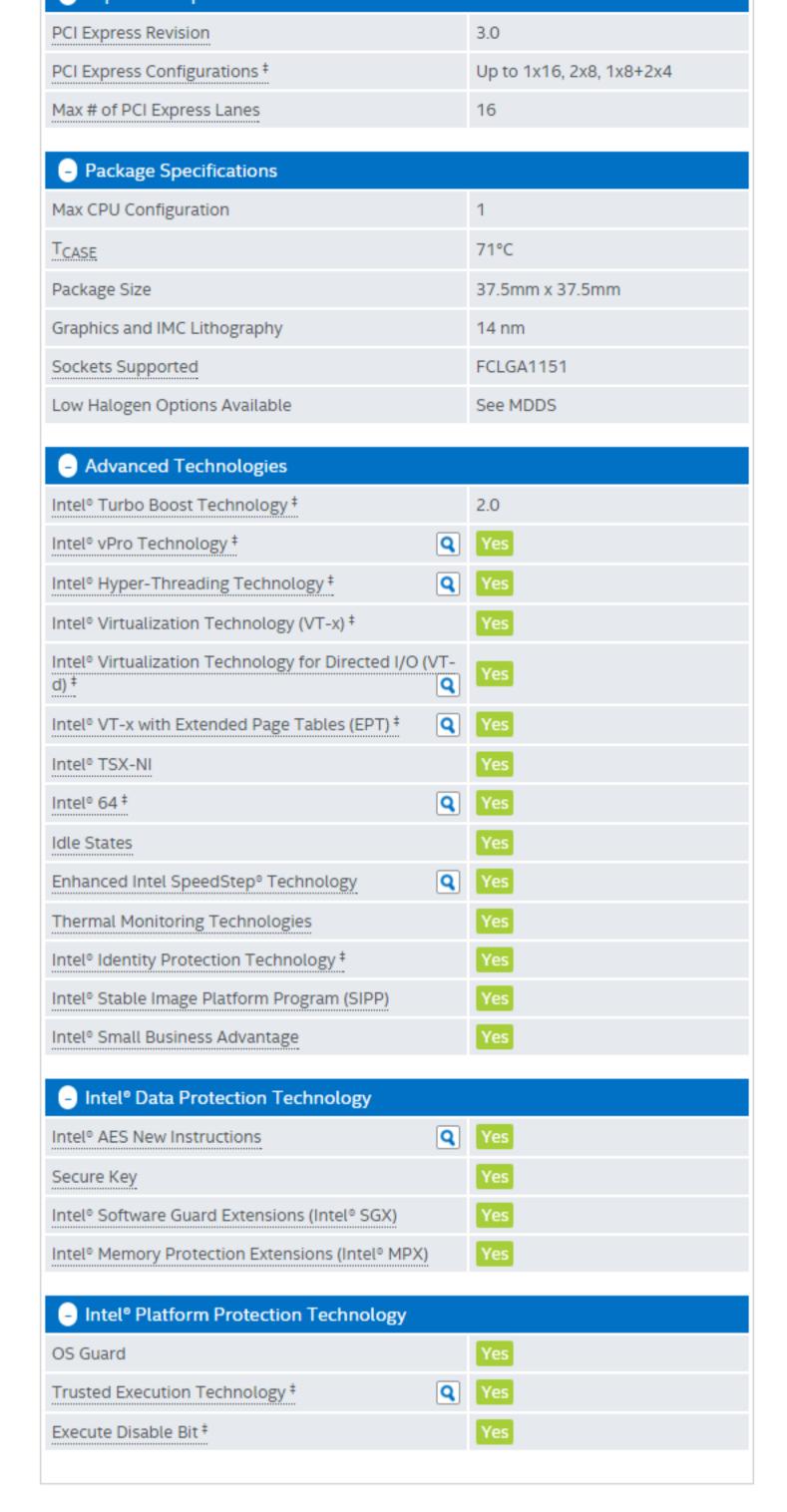


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PCN/MDDS Information

SR2L2 947202: PCN | MDDS 947559: MDDS 947566: MDDS



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Refer to Datasheet for formal definitions of product properties and features.

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

Some products can support AES New Instructions with a Processor Configuration update, in particular, i7-2630QM/i7-2635QM, i7-2670QM/i7-2675QM, i5-2430M/i5-2435M, i5-2410M/i5-2415M. Please contact OEM for the BIOS that includes the latest Processor configuration update.

‡ This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

"Conflict free" and "conflict-free" means "DRC conflict free", which is defined by the U.S. Securities and Exchange Commission rules to mean products that do not contain conflict minerals (tin, tantalum, tungsten and/or gold) that directly or indirectly finance or benefit armed groups in the Democratic Republic of the Congo (DRC) or adjoining countries. Intel also uses the term "conflict-free" in a broader sense to refer to suppliers, supply chains, smelters and refiners whose sources of conflict minerals do not finance conflict in the DRC or adjoining countries. Intel processors manufactured before January 1, 2013 are not confirmed conflict free. The conflict free designation refers to the processor only, not to any additional included accessories, such as heatsinks/coolers.

See http://www.intel.com/content/www/us/en/architecture-and-technology/hyper-threading/hyper-threading-technology.html?wapkw=hyper+threading for more information including details on which processors support Intel® HT Technology.

Max Turbo Frequency refers to the maximum single-core processor frequency that can be achieved with Intel® Turbo Boost Technology. See www.intel.com/technology/turboboost/ for more information.

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System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

For benchmarking data see http://www.intel.com/performance.

Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families. See http://www.intel.com/content/www/us/en/processors/processor-numbers.html for details.

Processors that support 64-bit computing on Intel® architecture require an Intel 64 architecture-enabled BIOS.

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